

12-26-2001

Q67596

Form PTO-1595 (modified)
(Rev. 03/01)
OMB No. 0651-0027

R



101954418

ET

U.S. DEPARTMENT OF COMMERCE
U.S. Patent and Trademark Office

To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):

Yukio ABE
Hideshi NAKATSU
Yasushi TAMURA
Yoshihiro KADA

12/12/01

2. Name and address of receiving party(ies):

HITACHI METALS, LTD.
2-1, Shibaura-1-chome, Minato-ku, Tokyo, Japan

QC675 U.S. PTO
10/012503

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

3. Nature of conveyance:

- ☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Other

Execution Date: November 26, 2001

Additional name(s) & address(es) attached? ☐ Yes ☒ No

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: November 26, 2001

A. Patent Application No.(s)

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

SUGHRUE MION, PLLC
2100 Pennsylvania Avenue, N.W.
Suite 800
Washington, D.C. 20037-3213

6. Total number of applications and patents involved:

1

7. Total fee (37 CFR 3.41): \$40.00

- ☒ Enclosed. Please charge any underpayment in connection with this Assignment to Deposit Account No. 19-4880.
☐ Authorized to be charged to deposit account

8. Deposit account number:

19-4880

(Attach duplicate copy of this page if paying by deposit account)

DO NOT USE THIS SPACE

9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Peter D. Olexy
Peter D. Olexy

Reg. No. 24,513

December 12, 2001

Date

Total number of pages including cover sheet, attachments, and documents: 2

Mail documents to be recorded with required cover sheet information to:

Commissioner of Patents & Trademarks
Box Assignment
Washington, D.C. 20231

12/21/2001 TDIAZ1 00000074 10012503

01 FC:581

40.00 OP

PATENT
REEL: 012381 FRAME: 0610

ASSIGNMENT

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar(\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by HITACHI METALS, LTD., a corporation organized under the laws of Japan, located at 2-1, Shibaura-1-chome, Minato-ku, Tokyo, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said HITACHI METALS, LTD., its successors and assigns, all my right, title and interest, in and for the United States of America, in and to "HIGH-HARDNESS PREHARDEN STEEL FOR COLD WORKING WITH EXCELLENT MACHINABILITY, DIE MADE OF THE SAME FOR COLD WORKING, AND METHOD OF WORKING THE SAME" invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith,

and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said HITACHI METALS, LTD., its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said HITACHI METALS, LTD.

Signed on the date(s) indicated aside signatures:

INVENTOR(S)

Date Signed

WITNESSES

(発明者フルネームサイン)

(署名日)

(立会人サイン)

1)	<u>Yukio Abe</u> Yukio ABE	<u>November 26, 2001</u>	<u>Kengo Maruta</u>
2)	<u>Hideshi Nakatsu</u> Hideshi NAKATSU	<u>November 26, 2001</u>	<u>Shozo Ohne</u>
3)	<u>Yasushi Tamura</u> Yasushi TAMURA	<u>November 26, 2001</u>	<u>Shozo Ohne</u>
4)	<u>Yoshihiro Kada</u> Yoshihiro KADA	<u>November 26, 2001</u>	<u>Shozo Ohne</u>
5)	_____	_____	_____
6)	_____	_____	_____
7)	_____	_____	_____
8)	_____	_____	_____
9)	_____	_____	_____